

# MINI USB CONNECTOR SERIES

#### 1. SCOPE

This specification covers performance, tests and quality requirements for **MINI USB CONNECTOR SERIES.** 

## 2. APPLICABLE DOCUMENT

The following documents form a part of this specification to the extent specified herein. In the event of conflict between the requirements of this specification and the product drawing, the product drawing shall take precedence. In the event of conflict between the requirements of this specification and the referenced documents, this specification shall take precedence.

## 2.1. TYCO SPECIFICATIONS

A.109-1: General Requirements for Test Specifications

B.109-197: Tyco Specification vs EIA and IEC Test Methods

C. 501-57070: Test Report

#### 3. REQUIREMENTS

## 3.1. DESIGN AND CONSTRUCTION

Product shall be of the design, construction and physical dimensions specified on the applicable product drawing.

#### 3.2. MATERIALS

- A. Housing: Thermoplastic, UL94V-0.
- B. Contact: Copper Alloy, Gold plating on contact area, Tin-lead or Tin plated on soldertails, Nickel underplated all over
- C. Front Shell: Copper Alloy, Nickel plated over Cu underplated all over.
- D. Rear Shell: Steel, Tin plated over Nickel underplated all over.

#### 3.3. RATINGS

A. Current Rating: 1.0 Ampere.

B. Voltage Rating: 30 VAC RMS Max.

C. Operating temperature: -40°C to +85°C

DR		DATE	APVD	DATE
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# 3.4. TEST CONDITION

The product is designed to meet the electrical, mechanical and environmental performance requirements specified in Figure 1.

# 3.5. TEST REQUIREMENTS AND PROCEDURES SUMMARY

TEST ITEM	REQUIREMENTS	PROCEDURE					
Examination of product	Meets requirements of product	Visual inspection					
drawing and Tyco Specification		No physical damage					
ELECTRICAL							
Low Level Contact	1).Initial: 50 m $\Omega$ Max.	EIA 364-23 (or MIL-STD-1344A,					
Resistance	2). After test: 50 m $\Omega$ Max.	Method 3002.1, Test Condition B)					
		Subject mated contacts assembled in					
		housing to 20mV maximum open circuit at 100 mA maximum					
Insulation Resistance	1).Initial: 100 M $\Omega$ Min.	EIA 364-21 (or MIL-STD-202F, Method					
	2). After test: 100 M $\Omega$ Min.	302, Test Condition B).					
	,	Test between adjacent contacts of					
		mated and unmated connector					
Dielectric Withstanding	100 V AC for one minute at sea level	assemblies.  EIA 364-20 (or MIL-STD-202F, Method					
Voltage	1) No flashover or insulation	301, Test Condition B)					
· chage	breakdown	Test between adjacent contacts of					
	2) Leakage current: 0.5mA Max.	mated and unmated connector					
		assemblies.					
Contact Capacitance	2 pF Maximum per Contact	EIA 364-30					
		Test between adjacent circuits of					
		unmated connector at 1 KHz.					
	MECHANICAL						
Contact Current Rating	1.0A at 250Vac Min.	EIA 364-70 Method B					
		When measured at an ambient					
		temperature of 25°C. With Power					
		applied to the contacts, the $\triangle T$ shall					
		not exceed + 30°C at any point in the USB connector under test					
Random Vibration	No discontinuity at 1 $\mu$ sec or longer.	EIA 364-28 Test Condition V Test					
Tandom vibration	Two discontinuity at 1 $\mu$ see of longer.	Letter A, (or MIL-STD-202F, Method					
		214, Test Condition 1, Test Letter A)					
		Subject mated connectors to 5.35 G's					
		rms. Fifteen minutes in each of three					
Discosional Observi	N E C 11 14	mutually perpendicular planes.					
Physical Shock	No discontinuity at 1 $\mu$ sec or longer.	EIA 364-27 Test Condition H (or MIL-STD-202F, Method 214B)					
		Subject mated connectors to 30G's					
		half-sine shock pulses of 11ms					
		duration. Three shocks in each					
		direction applied along three mutually					
		perpendicular planes, 18 total shock.					
Durability	No discontinuity at 1 $\mu$ sec or longer.	EIA 364-09					
		Mate and unmate Connector					
		assemblies for 5000cycles at maximum rated of 200 cycles per hour.					
		rated of 200 cycles per flour.					

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TEST ITEM	REQUIREMENTS	PROCEDURE
Connector Mating Force	3.57Kgf (35 Newtons) Max	EIA 364-13 Shall be measured with TENSION GAUGE or TENSION TESTER. Measure force necessary to mate assemblies at maximum rate of 12.5mm (or 0.492") per minute.
Connector Unmating Force	1) Initial: 0.71Kgf (7 Newtons) Min. 2) After test: 0.31Kgf (3 Newtons) Min.	EIA 364-13 Shall be measured with TENSION GAUGE or TENSION TESTER. Measure force necessary to mate assemblies at maximum rate of 12.5mm (or 0.492") per minute.
Cable Pull-out Force	Cable shall be not dislodge from cable.	EIA 364-38 Apply axial load of 40 Newtons to the cable for 1 minute. Shall be measured with TENSION GAUGE or TENSION TESTER in same direction.
	ENVIRONMENTAL	
Thermal Shock	Shall meet visual requirement, show no physical damage.	EIA 364-32, Test Condition I, (or MIL-202F, Method 107G Condition A.) Subject mated connectors to five cycles between -55°C to +85°C.
Humidity Test	Shall meet visual requirement, show no physical damage.	EIA 364-31, Test Condition A Method III, (or MIL-202F, Method 103B Test Condition B.) Subject mated connectors to 168 Hours (seven complete cycles)
Temperature Life	Shall meet visual requirement, show no physical damage.	EIA 364-17 Test Condition 3 Method A, Subject mated connectors to temperature life at 85℃ for 250hours
Solderability	The inspected area of each lead must have 95% solder coverage minimum.	Steam Aging Preconditioning: (1) Tin \ Tin-Cu Coating: 93+3/-5°C \ 100%RH \ 8hrs. <j-std-002 3="" aging="" category=""> (2) Other Coating: 93+3/-5°C \ 100%RH \ 1hrs. <j-std-002 2="" aging="" category=""> Solder pot temperature: 245±5°C, 5sec</j-std-002></j-std-002>
Resistance to Wave Soldering Heat	No physical damage shall occur.	Solder Temp. : 265±5°C, 10±0.5sec. Tyco spec. 109-202, Condition B
Resistance to Reflow Soldering Heat	No physical damage shall occur.	Pre-soak condition, 85°C/85% RH for 168 hours. Pre Heat: 150~200°C, 60~180sec. Heat: 217°C Min., 60~150sec. Peak Temp.: 260+0/-5°C, 20~40sec. Duration: 3 cycles Tyco spec. 109-201, Condition B

Figure1.

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# 3.6. PRODUCT QUALIFICATION AND REQUALIFICATION TEST SEQUENCE

	Test Group (a)				
Test or Examination	Α	В	С	D	Е
	Test Sequence (b)				
Examination of product	1,11	1,5	1,7	1,4	1,3
Low Level Contact Resistance	3,8	2,4			
Insulation Resistance			3		
Dielectric Withstanding Voltage			4		
Contact Capacitance			2		
Contact Current Rating				2	
Random Vibration	6				
Physical Shock	7				
Durability	5				
Connector Mating Force	2,10				
Connector Unmating Force	4,9				
Thermal Shock			5		
Humidity			6		
Temperature Life		3			
Solderability				3	
Resistance to Soldering Heat					2

Figure 2

 $\mbox{NOTE}: (\mbox{ a}) \mbox{ Numbers indicate sequence in which tests are performed.}$ 

(b) Discontinuities shall not take place in this test group, during tests.

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